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## WIDE BAND DPDT SWITCH

## DESCRIPTION

The $\mu$ PD5738T6N is a CMOS MMIC DPDT (Double Pole Double Throw) switch which is developed for mobile communications, wireless communications and another RF switching applications.

This device can operate within frequency from 0.01 to 2.5 GHz , having low insertion loss and high isolation performances. This device is housed in a 6 -pin plastic TSON (Thin Small Out-line Non-leaded) (T6N) package, which allows high-density surface mounting.

## FEATURES

- Supply voltage
- Switch control voltage
- Low insertion loss ${ }^{\text {Note }}$
- High isolation Note
- Handling power Note
: $\mathrm{VDD}=1.5$ to 3.6 V (2.8 V TYP.)
: $\mathrm{V}_{\text {cont }(H)}=1.5$ to 3.6 V (2.8 V TYP.)
: $\mathrm{V}_{\text {cont }}(\mathrm{L})=-0.2$ to +0.4 V (0 V TYP.)
: Lins $1=0.5 \mathrm{~dB}$ TYP. @ $\mathrm{f}=0.01$ to 0.05 GHz
: Lins2 = 0.8 dB TYP. @ $\mathrm{f}=0.05$ to 1.0 GHz
: Lins3 = 1.4 dB TYP. @ f=1.0 to 2.0 GHz
: Lins4 = 1.6 dB TYP. @ $\mathrm{f}=2.0$ to 2.5 GHz
: ISL1 = 45 dB TYP. @ $f=0.01$ to 0.05 GHz
: ISL2 = 22 dB TYP. @ f = 0.05 to 1.0 GHz
: ISL3 = 16 dB TYP. @ $\mathrm{f}=1.0$ to 2.0 GHz
: ISL4 = 15 dB TYP. @ f = 2.0 to 2.5 GHz
$: \operatorname{Pin}(1 \mathrm{~dB})=+20 \mathrm{dBm}$ TYP. @ $\mathrm{f}=1.0 \mathrm{GHz}$
: $\operatorname{Pin}(0.1 \mathrm{~dB})=+15 \mathrm{dBm}$ TYP. @ $\mathrm{f}=1.0 \mathrm{GHz}$
- High-density surface mounting: 6-pin plastic TSON (T6N) package ( $1.5 \times 1.5 \times 0.37 \mathrm{~mm}$ )
- High ESD voltage : machine-model 200 V (TYP.), human-body-model 3 kV (TYP.)

Note $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=2.8 \mathrm{~V}, \mathrm{~V}_{\text {cont }}(\mathrm{H})=2.8 \mathrm{~V}, \mathrm{~V}_{\text {cont }}(\mathrm{L})=0 \mathrm{~V}$

## APPLICATIONS

- Mobile communications
- Wireless communications
- Another RF switching applications


## ORDERING INFORMATION

| Part Number | Order Number | Package | Marking | Supplying Form |
| :---: | :---: | :---: | :---: | :--- |
| $\mu$ PD5738T6N-E2 | $\mu$ PD5738T6N-E2-A | 6-pin plastic TSON <br> (T6N) (Pb-Free) | C3X | •Embossed tape 8 mm wide <br> $\bullet$ Pin 1,6 face the perforation side of the tape <br> $\bullet$ Qty $3 \mathrm{kpcs} /$ reel |

Remark To order evaluation samples, please contact your nearby sales office.
Part number for sample order: $\mu$ PD5738T6N-A

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

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## PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



TRUTH TABLE

| V cont | INPUT1-OUTPUT1, INPUT2-OUTPUT2 | INPUT1-OUTPUT2, INPUT2-OUTPUT1 |
| :---: | :---: | :---: |
| Low | ON | OFF |
| High | OFF | ON |

Remark High: +2.8 V, Low: 0 V
ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}} \mathbf{= + 2 5 ^ { \circ }} \mathbf{C}$, unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\text {DD }}$ | -0.5 to +4.6 | V |
| Switch Control Voltage | $\mathrm{V}_{\text {cont }}$ | -0.5 to +4.6 | V |
| Voltage Difference | $\mathrm{V}_{\text {cont }}(\mathrm{H})$ <br> $-\mathrm{V}_{\mathrm{DD}}$ | +0.5 | V |
| Input Power | $\mathrm{P}_{\text {in }}$ | +23 | dBm |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -45 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

RECOMMENDED OPERATING RANGE ( $\mathrm{T}_{\mathrm{A}}=+\mathbf{+ 2 5 ^ { \circ }} \mathbf{C}$, unless otherwise specified)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\text {DD }}$ | +1.5 | +2.8 | +3.6 | V |
| Switch Control Voltage (H) | $\mathrm{V}_{\text {cont }(\mathrm{H})}$ | +1.5 | +2.8 | +3.6 | V |
| Switch Control Voltage (L) | $\mathrm{V}_{\text {cont }(\mathrm{L})}$ | -0.2 | 0 | +0.4 | V |

Remark $\mathrm{V}_{\mathrm{DD}}-0.4 \mathrm{~V} \leq \mathrm{V}_{\text {cont }(H)} \leq \mathrm{V}_{\mathrm{DD}}+0.2 \mathrm{~V}$

## ELECTRICAL CHARACTERISTICS

$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{VDD}_{\mathrm{DD}}=2.8 \mathrm{~V}, \mathrm{~V}_{\text {cont }(H)}=2.8 \mathrm{~V}, \mathrm{~V}_{\text {cont }(\mathrm{L})}=0 \mathrm{~V}, \mathrm{Pin}=0 \mathrm{dBm}, \mathrm{Z}_{0}=50 \Omega\right.$, DC blocking capacitors
$=10000 \mathrm{pF}$, unless otherwise specified)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Insertion Loss 1 | Lins 1 | $\mathrm{f}=0.01$ to 0.05 GHz | - | 0.5 | 0.9 | dB |
| Insertion Loss 2 | Lins2 | $\mathrm{f}=0.05$ to 1.0 GHz | - | 0.8 | 1.2 | dB |
| Insertion Loss 3 | Lins3 | $\mathrm{f}=1.0$ to 2.0 GHz | - | 1.4 | 1.8 | dB |
| Insertion Loss 4 | Lins4 | $\mathrm{f}=2.0$ to 2.5 GHz | - | 1.6 | 2.0 | dB |
| Isolation 1 | ISL1 | $\mathrm{f}=0.01$ to 0.05 GHz | 35 | 45 | - | dB |
| Isolation 2 | ISL2 | $\mathrm{f}=0.05$ to 1.0 GHz | 18 | 22 | - | dB |
| Isolation 3 | ISL3 | $\mathrm{f}=1.0$ to 2.0 GHz | 13 | 16 | - | dB |
| Isolation 4 | ISL4 | $\mathrm{f}=2.0$ to 2.5 GHz | 12 | 15 | - | dB |
| Return Loss 1 | RL1 | $\mathrm{f}=0.01$ to 1.0 GHz | 13 | 18 | - | dB |
| Return Loss 2 | RL2 | $\mathrm{f}=1.0$ to 2.5 GHz | 8 | 12 | - | dB |
| 0.1 dB Loss Compression Input Power ${ }^{\text {Note } 1}$ | Pin (0.1 dB) | $\mathrm{f}=1.0 \mathrm{GHz}$ | +10 | +15 | - | dBm |
| 1 dB Loss Compression Input Power ${ }^{\text {Note } 2}$ | Pin (1 dB) | $\mathrm{f}=1.0 \mathrm{GHz}$ | - | +20 | - | dBm |
| Supply Current | IdD | $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\text {cont }}=2.8 \mathrm{~V}$, RF off | - | 0.01 | 1 | $\mu \mathrm{A}$ |
| Switch Control Current | Icont | $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\text {cont }}=2.8 \mathrm{~V}$, RF off | - | 0.01 | 1 | $\mu \mathrm{A}$ |
| Switch Control Speed | tsw | $\mathrm{f}=1.0 \mathrm{GHz}$ | - | 0.4 | 1 | $\mu \mathrm{S}$ |

Notes 1. Pin ( 0.1 dB ) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.
2. $\operatorname{Pin}(1 \mathrm{~dB})$ is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution DC blocking capacitors are necessary. Please do not supply any DC bias to the terminals (INPUT1, INPUT2, OUTPUT1, OUTPUT2).
The value of DC blocking capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system.

## EVALUATION CIRCUIT



Caution This IC has pull down resistances inside between each RF line and GND line, which bias each RF pin internally to GND, then the IC cannot be used for DC switching.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

## ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



USING THE EVALUATION BOARD

| Symbol | Values |
| :---: | :---: |
| C1 | 10000 pF |
| C2 | 1000 pF |

TYPICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{dD}}=2.8 \mathrm{~V}, \mathrm{~V}_{\text {cont }}(\mathrm{H})=2.8 \mathrm{~V}, \mathrm{~V}_{\text {cont }}(\mathrm{L})=0 \mathrm{~V}, \mathrm{P}_{\text {in }}=0 \mathrm{dBm}\right.$, $Z_{0}=50 \Omega$, DC blocking capacitors $=10000 \mathrm{pF}$, unless otherwise specified)


Remark The graphs indicate nominal characteristics.

INPUT1, 2-OUTPUT1, 2
INSERTION LOSS vs. FREQUENCY


INPUT1, 2-OUTPUT1, 2
RETURN LOSS vs. FREQUENCY


INSERTION LOSS vs. INPUT POWER


Remark The graphs indicate nominal characteristics.

## MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

## 6-PIN PLASTIC TSON (UNIT: mm)

## MOUNTING PAD



SOLDER MASK


Solder thickness : 0.08 mm

Remark The mounting pad and solder mask layouts in this document are for reference only.
When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

## PACKAGE DIMENSIONS

## 6-PIN PLASTIC TSON (T6N) (UNIT: mm)



## RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method |  | Soldering Conditions | Condition Symbol |
| :--- | :--- | :--- | :---: |
| Infrared Reflow | Peak temperature (package surface temperature) | $: 260^{\circ} \mathrm{C}$ or below | IR260 |
|  | Time at peak temperature | $: 10$ seconds or less |  |
|  | Time at temperature of $220^{\circ} \mathrm{C}$ or higher | $: 60$ seconds or less |  |
|  | Preheating time at 120 to $180^{\circ} \mathrm{C}$ | $: 120 \pm 30$ seconds |  |
|  | Maximum number of reflow processes | $: 3$ times |  |
|  | Maximum chlorine content of rosin flux (\% mass) | $: 0.2 \%(\mathrm{Wt}$. ) or below |  |
| Partial Heating | Peak temperature (terminal temperature) | $: 350^{\circ} \mathrm{C}$ or below | HS350 |
|  | Soldering time (per side of device) | $: 3$ seconds or less |  |
|  | Maximum chlorine content of rosin flux (\% mass) | $: 0.2 \%(\mathrm{Wt}$. ) or below |  |

Caution Do not use different soldering methods together (except for partial heating).


[^0]:    The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

